

Emerging Trends in Microelectronics, Communication and Intelligent Systems

Proceedings of the International Conference, ETMCIS 2024

This book comprises select proceedings from the International Conference on Emerging Trends in Microelectronics, Communication and Intelligent Systems (ETMCIS 2024). It explores the synergies and intersections between engineering, artificial intelligence, microelectronics, communication, and signal processing. The book showcases the forefront areas of research in engineering, presenting readers with up-to-date insights and breakthrough discoveries. It highlights the latest studies, methodologies, and experimental findings, ensuring readers stay at the forefront of knowledge in these rapidly evolving fields. The book emphasizes real-world examples and implementation strategies to help readers grasp how these technologies can be leveraged to solve complex problems and improve existing systems.

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